

## J203, J204 N-Channel JFET

### Features

- InterFET [N0016SH Geometry](#)
- Low Noise: 5 nV/VHz Typical
- Low Ciss: 4pF Typical
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

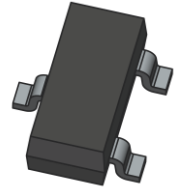
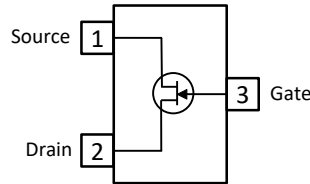
### Applications

- Audio Amplifiers
- Small Signal Amplifier
- Ultrahigh Impedance Pre-Amplifier
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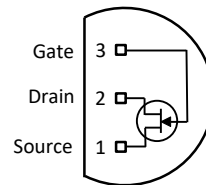
### Description

The -40V InterFET J203 and J204 are targeted for sensitive amplifier stages for mid-frequencies designs. Gate leakages are typically less than 10pA at room temperatures.

SOT23 Top View



TO-92 Bottom View



### Product Summary

Parameters		J203 Min	J204 Min	Unit
$BV_{GSS}$	Gate to Source Breakdown Voltage	-40	-25	V
$I_{DSS}$	Drain to Source Saturation Current	4	0.2	mA
$V_{GS(off)}$	Gate to Source Cutoff Voltage	-2	-0.3	V
$G_{FS}$	Forward Transconductance	1500	500	$\mu S$

### Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
J203; J204	Through-Hole	TO-92	Bulk
SMPJ203; SMPJ204	Surface Mount	SOT23	Bulk
SMPJ203TR; SMPJ204TR	7" Tape and Reel: Max 3,000 Pieces 13" Tape and Reel: Max 9,000 Pieces	SOT23	Minimum 1,000 Pieces Tape and Reel
J203COT; J204COT	Chip Orientated Tray (COT Waffle Pack)	COT	400/Waffle Pack
J203CFT; J204CFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack



**Disclaimer:** It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.

## Electrical Characteristics

### Maximum Ratings (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Value	Unit
$V_{RGS}$ Reverse Gate Source and Gate Drain Voltage	-40	V
$I_{FG}$ Continuous Forward Gate Current	50	mA
$P_D$ Continuous Device Power Dissipation	360	mW
$P$ Power Derating	3.27	mW/ $^\circ\text{C}$
$T_J$ Operating Junction Temperature	-55 to 125	$^\circ\text{C}$
$T_{STG}$ Storage Temperature	-65 to 200	$^\circ\text{C}$

### Static Characteristics (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Conditions	J203			J204			Unit
		Min	Typ	Max	Min	Typ	Max	
$V_{(BR)GSS}$ Gate to Source Breakdown Voltage	$V_{DS} = 0V, I_G = -1\mu\text{A}$	-40			-25			V
$I_{GSS}$ Gate to Source Reverse Current	$V_{GS} = -20V, V_{DS} = 0V$			-100			-100	pA
$V_{GS(OFF)}$ Gate to Source Cutoff Voltage	$V_{DS} = 20V, I_D = 10\text{nA}$	-2		-10	-0.3		-2	V
$I_{DSS}$ Drain to Source Saturation Current	$V_{GS} = 0V, V_{DS} = 20V$ (Pulsed)	4		20	0.2	1.2	3	mA
$I_G$ Gate Operating Current	$V_{DG} = 20V, I_D = I_{DSS(min)}$		-10			-10		pA

### Dynamic Characteristics (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Conditions	J203			J204			Unit
		Min	Typ	Max	Min	Typ	Max	
$G_{FS}$ Forward Transconductance	$V_{DS} = 20V, V_{GS} = 0V, f = 1\text{kHz}$	1500			500	1500		$\mu\text{S}$
$G_{OS}$ Output Conductance	$V_{DS} = 20V, V_{GS} = 0V, f = 1\text{kHz}$		10			2.5		$\mu\text{S}$
$C_{ISS}$ Input Capacitance	$V_{DS} = 20V, V_{GS} = 0V, f = 1\text{MHz}$		4			4		pF
$C_{RSS}$ Reverse Transfer Capacitance	$V_{DS} = 20V, V_{GS} = 0V, f = 1\text{MHz}$		1			1		pF
$e_n$ Noise Voltage	$V_{DS} = 10V, V_{GS} = 0V, f = 1\text{kHz}$		5			10		$\text{nV}/\sqrt{\text{Hz}}$

## SOT23 (TO-236AB) Mechanical and Layout Data

### Package Outline Data



1. All linear dimensions are in millimeters.
2. Package weight approximately 0.12 grams
3. Molded plastic case UL 94V-0 rated
4. For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
5. Bulk product is shipped in standard ESD shipping material
6. Refer to JEDEC standards for additional information.

### Suggested Pad Layout



1. All linear dimensions are in millimeters.
2. The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.